

PRELIMINARY DATA SHEET

SMP1334-084LF: 100 W High-Power Silicon PIN Diode

Applications

- Low-loss, high-power switches
- Low-distortion attenuators

Features

- High RF power handling: 100 W
- Low thermal resistance: 10 °C/W
- Low series resistance: 0.45 Ω typical @ 100 mA
- Low total capacitance: 0.45 pF maximum @ 30 V
- Small QFN (2 x 2 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



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Description

The SMP1334-084LF is a surface-mountable, low-capacitance silicon PIN diode designed as a series-connected PIN diode for high-power, high-volume switch and attenuator applications from 10 MHz to beyond 6 GHz.

Typical resistance at 100 mA is 0.45 Ω and maximum capacitance at 30 V is 0.45 pF. The combination of low capacitance, low parasitic inductance, and nominal 50 μ m l-region width, makes the SMP1334-084LF useful in large signal switches and attenuator applications.

The device has a 1 W dissipation power rating, which makes it capable of handling up to 100 W @ 25 °C Continuous Wave (CW) in a series-connected transmit/receive (T/R) switch.

Design information for high power switches may be found in the Skyworks Application Note, *Design With PIN Diodes* (document number 200312).

1

Parameter	Symbol	Minimum	Maximum	Units
Forward current	lf		200	mA
Reverse voltage	VR		200	V
Dissipated power @ 85 °C	PD		1	W
Peak pulse power dissipation @ 85 $^\circ\text{C}$ (10% duty cycle)			10	W
Operating temperature	Та	-55	+85	°C
Storage temperature	Тята	-55	+200	°C
Junction temperature	TJ	-55	+175	°C
Electrostatic discharge: Charged-Device Model (CDM), Class 4 Human Body Model (HBM), Class 3A Machine Model (MM), Class C	ESD		1100 5000 400	V V V

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Parameter	Symbol	Test Condition	Min	Typical	Мах	Units
Forward voltage	VF	IF = 10 mA		0.75		V
Reverse leakage current	IR	$V_R = 200 V$			10	μA
Series resistance	Rs1	IF = 1 mA, f = 100 MHz		16.5	20	Ω
	Rs10	I⊧ = 10 mA, f = 100 MHz		2.0	2.5	Ω
	Rs100	$l_F = 100 \text{ mA}, f = 100 \text{ MHz}$		0.45		Ω
Total capacitance	Ст30	$V_R=30 \; V, f=1 \; MHz$		0.40	0.45	pF
Series inductance	Ls			0.37		nH
Minority carrier lifetime	TL	IF = 10 mA		700		ns
I region width	W			50		μm
Thermal resistance (Note 2)	Oic	Junction-to-case		10		°C/W
Peak thermal resistance	ΘΡ	Single, 1 µs pulse width, junction-to-case (10% duty cycle)		1		°C/W

Table 2. SMP1334-084LF Electrical Specifications (Note 1) (Ta = +25 $^{\circ}$ C, Unless Otherwise Noted)

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Note 2: Assume a thermal resistance of 90 °C/W for the junction-to-bottom of the circuit board.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1334-084LF are provided in Table 1. Electrical specifications are provided in Table 2. Typical DC performance characteristics of the SMP1334-084LF are illustrated in Figures 1, 2, and 3.

The SMP1334-084LF Evaluation Board is used to test the performance of the SMP1334-084LF PIN Diode. Figure 4 shows a bias schematic, and Table 3 lists the Evaluation Board Bill of Materials. Typical RF performance of the SMP1334-084LF using the schematic shown in Figure 4 is summarized in Table 4 and illustrated in Figures 5, 6, and 7.

An assembly drawing for the Evaluation Board is shown in Figure 8. The layer detail physical characteristics are provided in Figure 9.

Package Dimensions

The PCB layout footprint for the SMP1334-084LF is provided in Figure 10. Typical case markings are shown in Figure 11.

Typical DC Performance Characteristics

(TA = 25 °C, Unless Otherwise Noted)

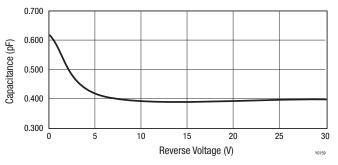


Figure 1. Capacitance vs Reverse Voltage @ 1 MHz

Package dimensions for the SMP1334-084LF are provided in Figure 12, and tape and reel dimensions are provided in Figure 13.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1334-084LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

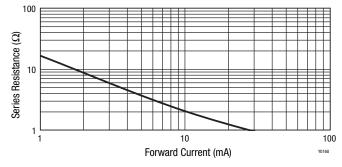


Figure 2. Series Resistance vs Forward Current @ 100 MHz

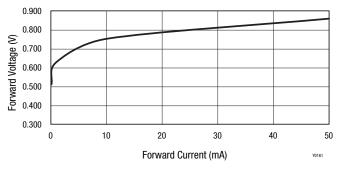


Figure 3. Forward Voltage vs Forward Current

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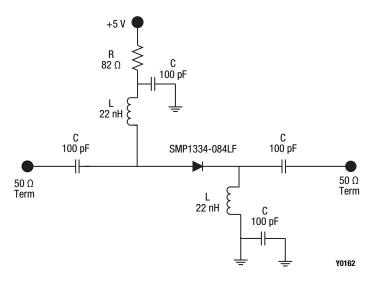


Figure 4. SMP1334-084LF Bias Schematic

Table 3. Evaluation Board Bill of Materials for EN33-D515-01_V3 (Tuned Circuit)

Component	Value	Size	QTY	Manufacturer	Mfg. Part Number	Characteristics
С	100 pF	0402	4	Murata	GRM1555C1H101JZ01	5% COG 50 V
L	22 nH	0402	2	Murata	HK100522NJ-T	5%
R	82 Ω	0402	1	Panasonic	ERJ2GEJ820X	5%, 0.1 W

Table 4. Typical RF Performance @ 25 °C, f = 2.6 GHz

Parameter	Typical	Units			
Un-tuned					
Insertion loss	0.22	dB			
Return loss	15	dB			
Isolation	-6.4	dB			
With 22 nH Bias Circuit					
Insertion loss	0.5	dB			
Return loss	11.7	dB			
Isolation	-8.2	dB			
Max power	+50	dBm			

4

Typical RF Performance Characteristics

(Top = +25 °C, Characteristic Impedance [Zo] = 50 Ω , EVB Optimized with Bias Circuit, Unless Otherwise Noted)

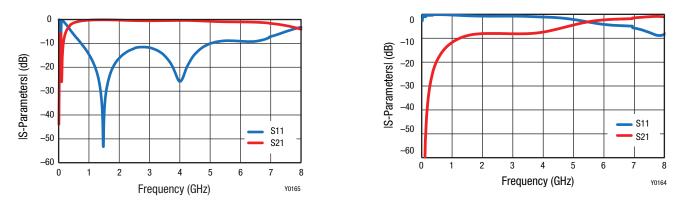


Figure 5. S-Parameter Magnitude vs Frequency If = 50 mA

Figure 6. S-Parameter Magnitude vs Frequency VREV = -30 V

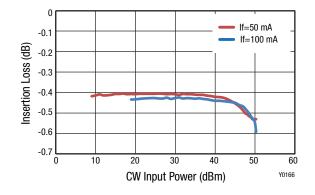


Figure 7. Insertion Loss vs CW Input Power f=2.6 GHz

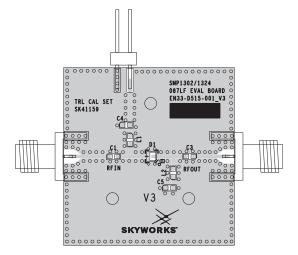
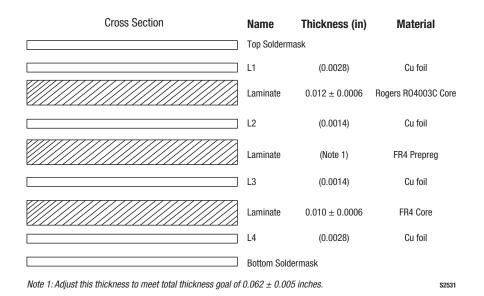
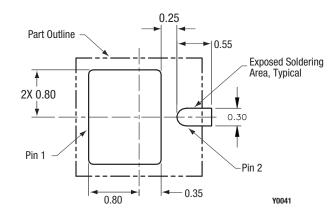


Figure 8. SMP1334-084LF Evaluation Board

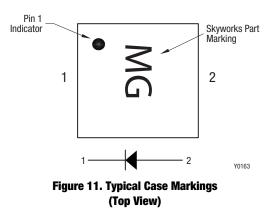
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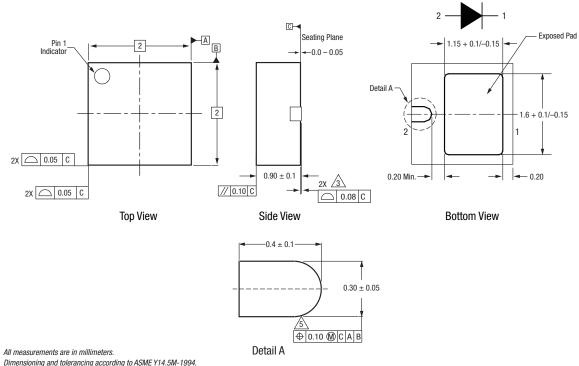










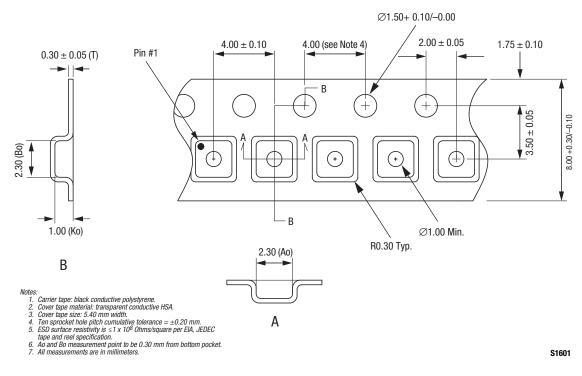


Coplanarity applies to the exposed heat sink slug as well as the terminals..

Dimension applies to metalized terminal and is measured between 0.10 mm and 0.30 mm from terminal tip.

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Figure 12. SMP1334-084LF Package Dimensions





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Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SMP1334-084LF: 100 W High-Power Silicon PIN Diode	SMP1334-084LF	SMP1334-084LF EVB

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